MODEL 572A-40
DEEP ACCESS-LONG REACH
THERMOSONIC WIRE AND RIBBON BONDER

0.5 to 2.0 mil (12.7 to 50 µm) diameter wire and
up to 1 x 10 mil (25.4 x 254µm) ribbon

STANDARD FEATURES:

¬ HYBOND Soft Touch™ energy system.
¬ Front panel ultrasonic test button.
¬ Deep vertical access of 0.53 in. (1.34cm).
¬ Long horizontal reach of 6.5 in. (16.5cm).
¬ 0.5 and 2 inch spool mounts standard.
¬ Loop height control adjustment.
¬ Motorized vertical wire feed.
¬ 1-1-2, 1-2-2 and 1-2-1 stitch capability.
¬ Deep access wire-in-tool 90 deg. wire feed.
¬ Swing away clamps for easier wire threading.
¬ Variable angle microscope mount.
¬ Audio and visual bond fault indicators.
¬ Independent 1st and 2nd bond controls.
¬ Front panel feed switch for manual tail adjust.
¬ 10x12 in. (25.4x30.3 cm) X-Y work platform.
¬ LED display for monitoring temperature.
¬ Independent lever for Z bond head control.
¬ Wire and ribbon bonding capability.

Imitated but never duplicated, HYBOND’s exclusive Soft Touch™ force ramping system bonds effectively with less trauma to sensitive materials like GaAs and InP. Superior wire control is provided by the motorized feed system which features clamps capable of feeding wire and ribbon, dial adjustable tail length, switch for manual tail length adjustment and clamp pull back dial adjustment to allow bonding and cutting of softer (higher elongation) wires than conventionally used for wedge bonding. Model 572A-40 includes front panel independent controls for 1st and 2nd bond U/S, Time & Force as well as for the built in workstage temperature controller. The 572A-40 has a proven track record of safe and effective wire and ribbon bonding worldwide.
Partial List of Available Options:

! OP-06S6  Leica Stereo Zoom Microscope.
! OP-06A   Nikon SMZ-660 Microscope.
! OP-08A   Dual Fiberoptic Illuminator.
! OP-12    240VAC 50/60Hz Input Wiring.
! OP-30A   8:1 X-Y Manipulator.

! OP-44    High/Low U/S Power Selector.
! OP-84    Heated Transducer For Tool Heat.
! WST-15A  Heated Workstage, 2.125in. Top.
! WST-19A  Heated Workstage, 4x6in. Top.

Specifications for Model 572A-40:

! Ultrasonic (U/S) System: PLL self tuning, 62.5KHz (nominal) system (±2.5KHz).
! U/S Power Range: 0-1 Watt on low (default) setting and 0-2 Watts on high setting.
! Bond Time Range: 10mSec. to 150mSec.
! Bond Force Range: 15gr. to 120gr.
! Temperature control Range: Ambient to 250 degrees Celsius.
! Bondable Wire Diameters: 0.5 to 2.0 mil (12.7 to 50µm) diameter.
! Bondable Ribbon Dimensions: Up to 1x10mil (25.4 x 254µm).
! Bondable Wire/Ribbon Materials: Gold and aluminum.
! Bond head movement: Manual
! Bond actuation: Switch at fixed height. Activated by lever.
! Z Travel/Vertical Bonding Window: 0.5in. (1,27cm)/60-100mils (152-254µm)
! Table Motion: 4:1, manual.
! Input Power Requirements: 110 VAC 50/60Hz @ 10A max. For 240VAC bonder must have OP-12
! Minimum Bench Space Required: 20.0 x 25.0 in. (50.8 x 63.5cm).
! Unit Weight/Shipping Weight: 70lbs (31,8Kg)/150lbs (68,2Kg). Shipping weight may vary.
! Industry Standards: CE.